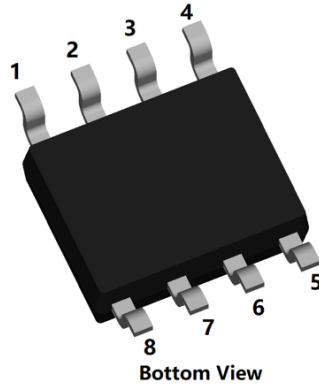
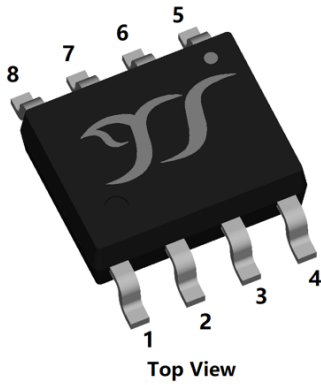
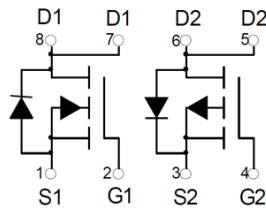


N-Channel and P-Channel Complementary Power MOSFET



SOP-8



Product Summary

NMOS

• V_{DS}	30V
• I_D	6A
• $R_{DS(ON)}$ (at $V_{GS}=10V$)	< 18mohm
• $R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 30mohm

PMOS

• V_{DS}	-30V
• I_D	-5A
• $R_{DS(ON)}$ (at $V_{GS}=-10V$)	< 45mohm
• $R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	< 65mohm

General Description

- Trench Power LV MOSFET technology
- High density cell design for low $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Wireless charger
- Load switch
- Power management

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-source Voltage		V_{DS}	30	-30	V
Gate-source Voltage		V_{GS}	± 20	± 20	V
Drain Current	$T_A=25^\circ C$	I_D	6	-5	A
	$T_A=70^\circ C$		4.8	-4	
Pulsed Drain Current ^A		I_{DM}	24	-20	A
Total Power Dissipation	$T_A=25^\circ C$	P_D	2	2	W
	$T_A=70^\circ C$		1.2	1.2	
Thermal Resistance Junction-to-Ambient ^B		$R_{\theta JA}$	62.5	62.5	$^\circ C/W$
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	-55~+150	$^\circ C$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJS4606A	F2	YJS4606A	4000	8000	64000	13" reel



YJS4606A

■ N-MOS Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	2.2	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =6A		14	18	mΩ
		V _{GS} =4.5V, I _D =5A		23	30	
Diode Forward Voltage	V _{SD}	I _S =6A, V _{GS} =0V			1.2	V
Gate resistance	R _G	f=1MHz, Open drain	-	2.5	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	6	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, f=1MHZ		526		pF
Output Capacitance	C _{oss}			78		
Reverse Transfer Capacitance	C _{rss}			69		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =5.6A		12.22		nC
Gate-Source Charge	Q _{gs}			2.37		
Gate-Drain Charge	Q _{gd}			2.31		
Reverse Recovery Charge	Q _{rr}	I _F =5.6A, di/dt=100A/us		1.28		ns
Reverse Recovery Time	t _{rr}			16.5		
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DS} =15V, I _D =5.6A R _{GEN} =3Ω		5		ns
Turn-on Rise Time	t _r			28.2		
Turn-off Delay Time	t _{D(off)}			12.8		
Turn-off fall Time	t _f			21.6		

A. Pulse Test: Pulse Width ≤ 300us, Duty cycle ≤ 2%.

B. R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJC} is guaranteed by design, while R_{θJA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



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■ P-MOS Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$			-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.5	-2.4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-5A$		35	45	m Ω
		$V_{GS}=-4.5V, I_D=-3.5A$		49	65	
Diode Forward Voltage	V_{SD}	$I_S=-5A, V_{GS}=0V$			-1.2	V
Gate resistance	R_G	f=1MHz, Open drain	-	10.5	-	Ω
Maximum Body-Diode Continuous Current	I_S		-	-	-5	A
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$		719		pF
Output Capacitance	C_{oss}			78		
Reverse Transfer Capacitance	C_{rss}			64		
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=-10V, V_{DS}=-15V, I_D=-5.1A$		14.23		nC
Gate-Source Charge	Q_{gs}			3.16		
Gate-Drain Charge	Q_{gd}			2		
Reverse Recovery Charge	Q_{rr}	$I_F=-5.1A, di/dt=100A/us$		5.3		
Reverse Recovery Time	t_{rr}			30		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V, V_{DS}=-15V, I_D=5.1A$ $R_{GEN}=3\Omega$		7.4		ns
Turn-on Rise Time	t_r			37		
Turn-off Delay Time	$t_{D(off)}$			31.6		
Turn-off fall Time	t_f			42		

C. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

D. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



■ N-MOS Typical Performance Characteristics

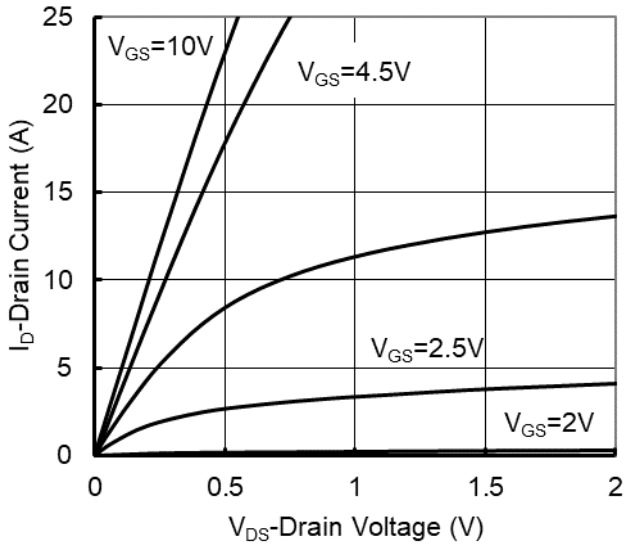


Figure1. Output Characteristics

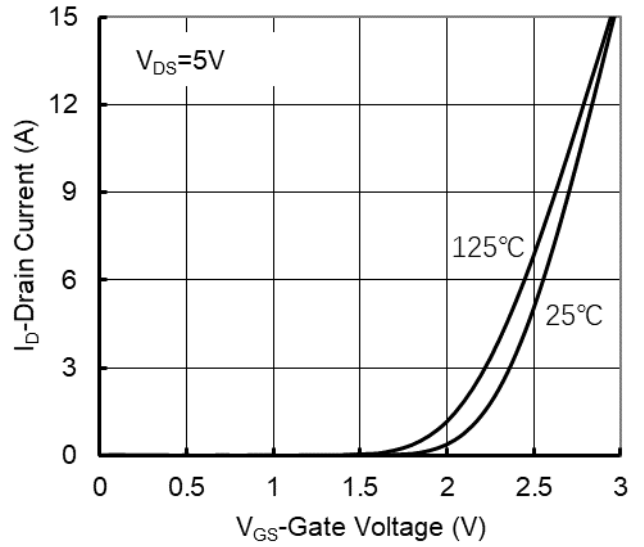


Figure2. Transfer Characteristics

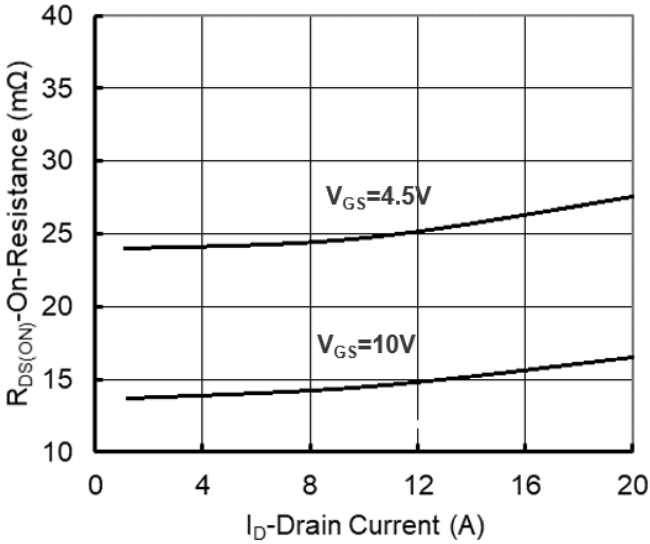


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

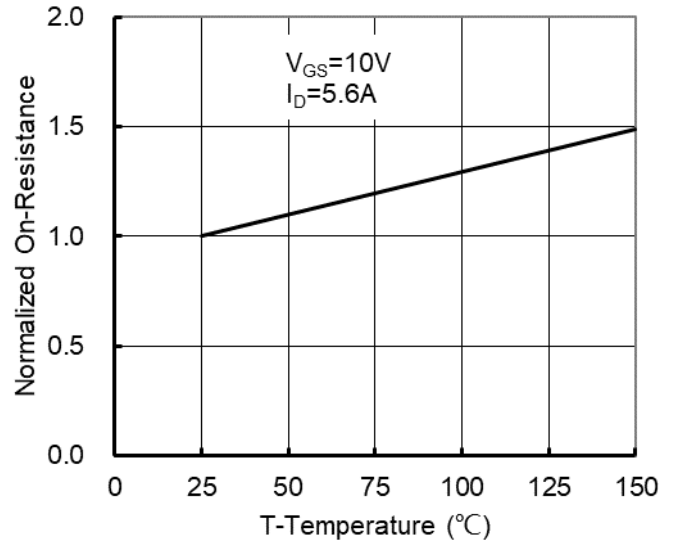


Figure 4: On-Resistance vs. Junction Temperature

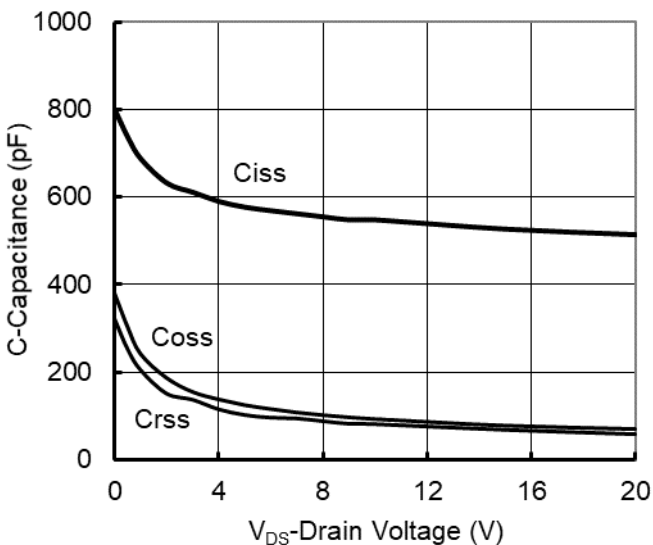


Figure5. Capacitance Characteristics

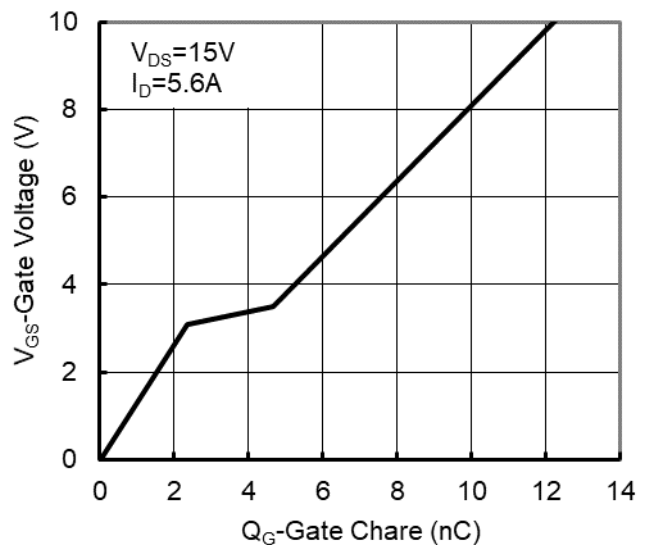


Figure6. Gate Charge



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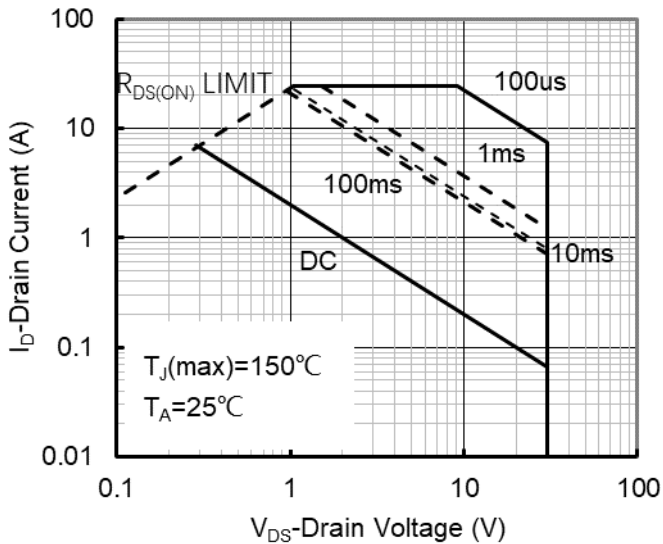


Figure7. Safe Operation Area

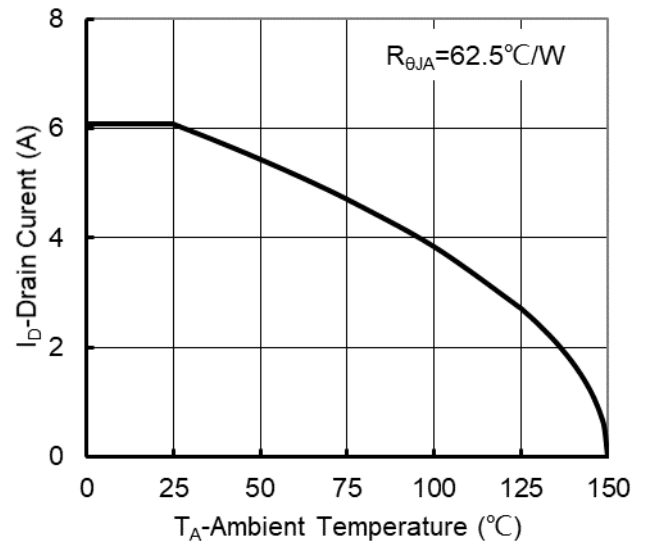


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

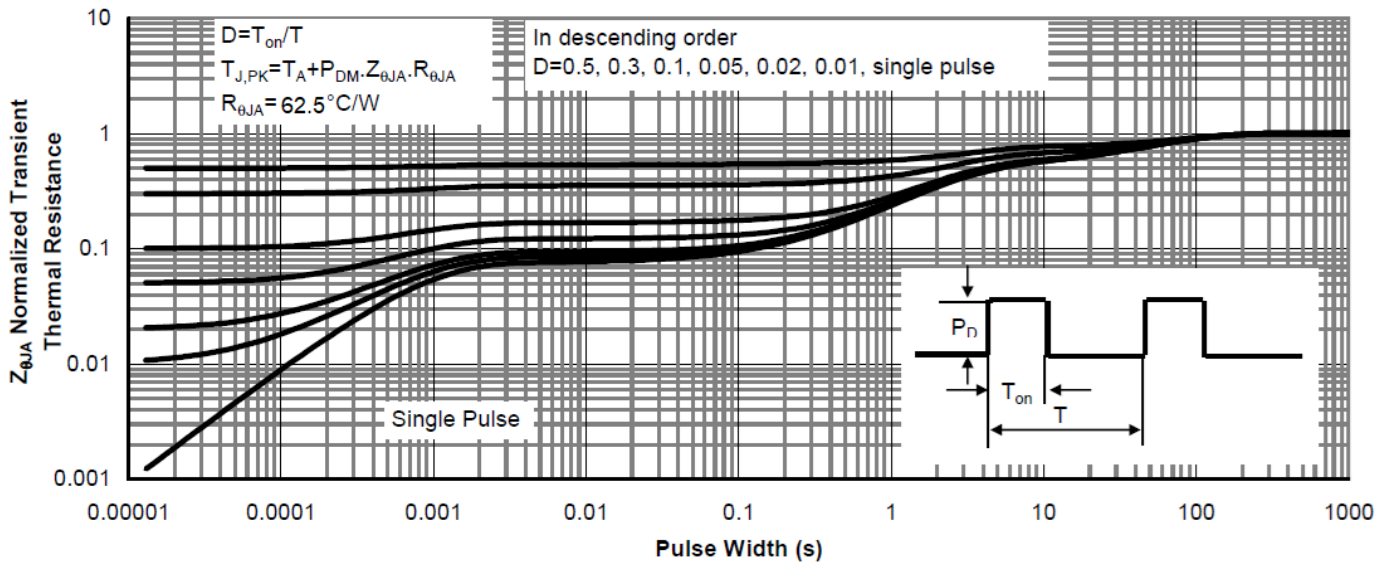


Figure9. Normalized Maximum Transient Thermal Impedance



■ P-MOS Typical Performance Characteristics

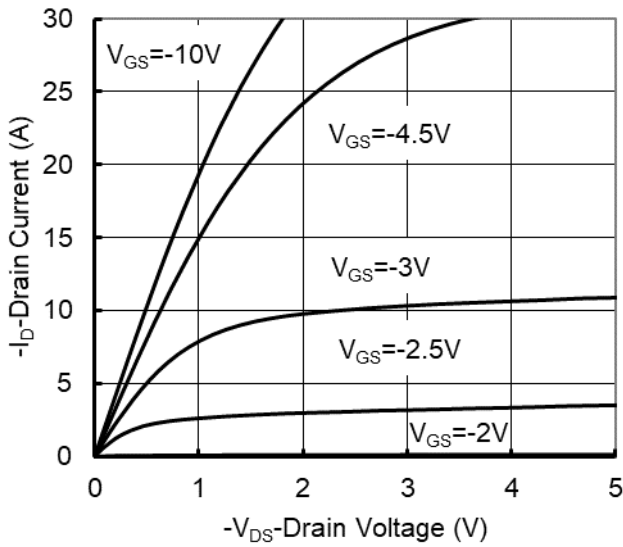


Figure1. Output Characteristics

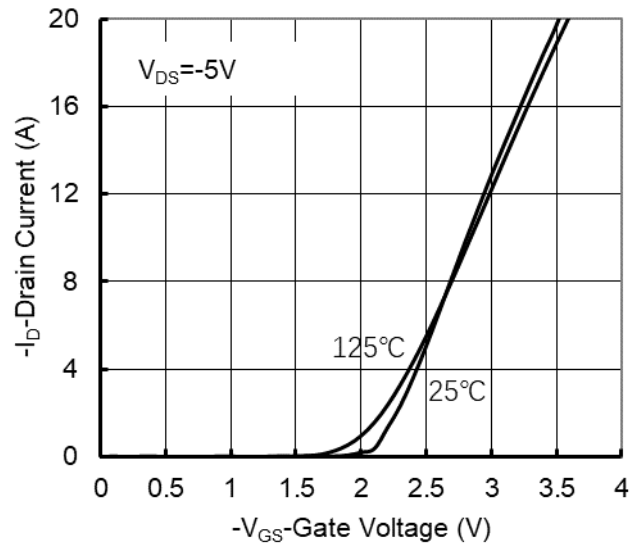


Figure2. Transfer Characteristics

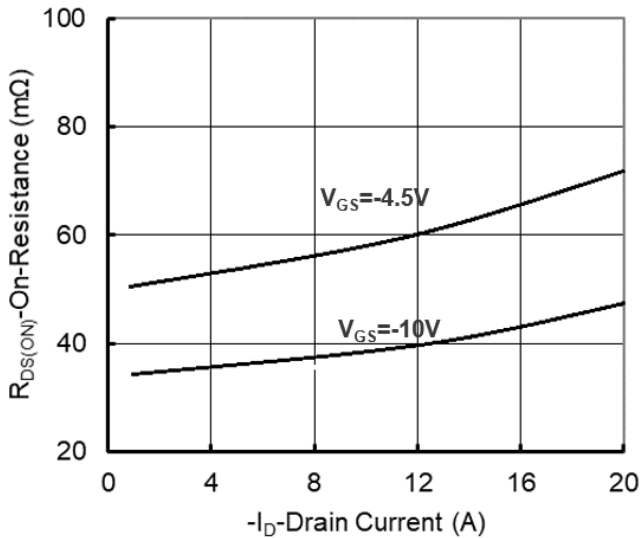


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

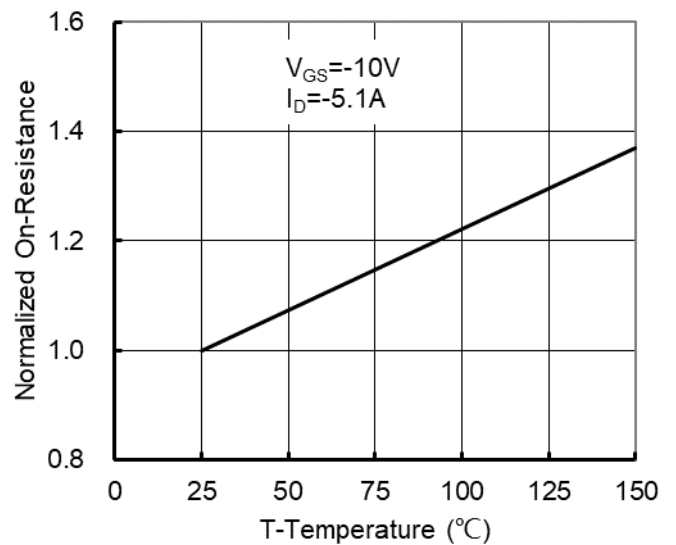


Figure 4: On-Resistance vs. Junction Temperature

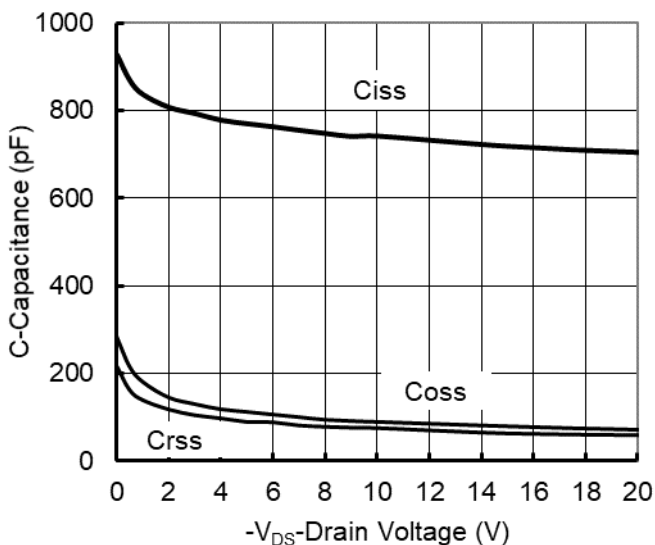


Figure5. Capacitance Characteristics

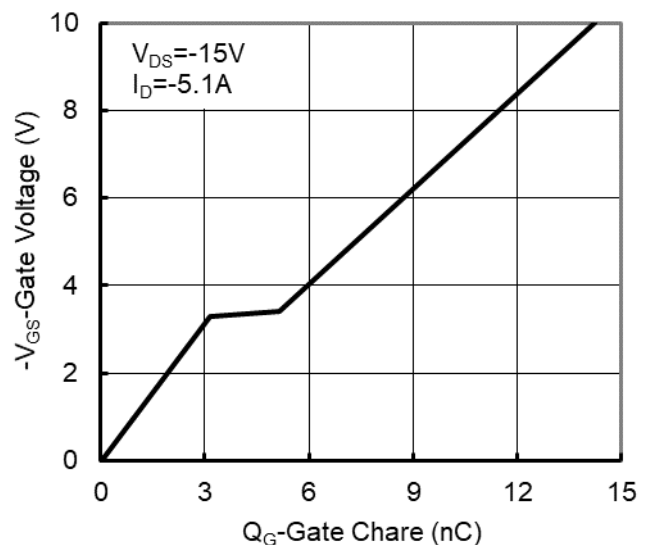


Figure6. Gate Charge



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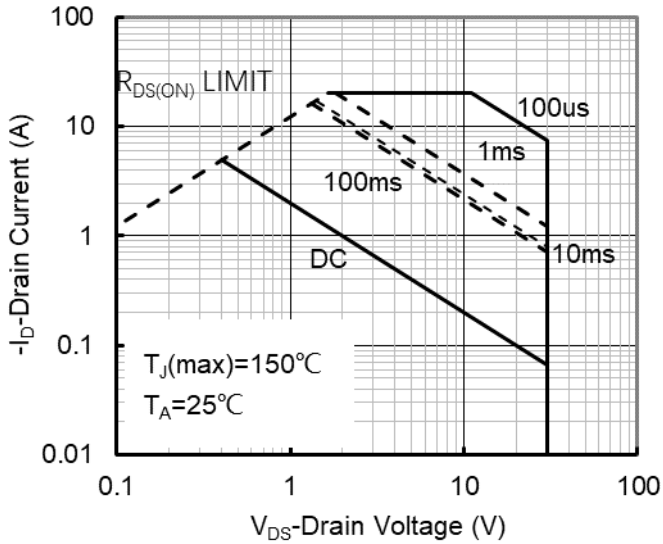


Figure7. Safe Operation Area

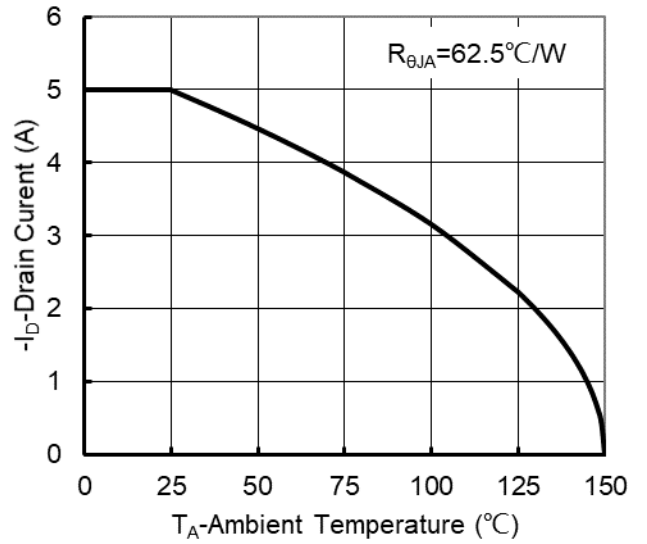


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

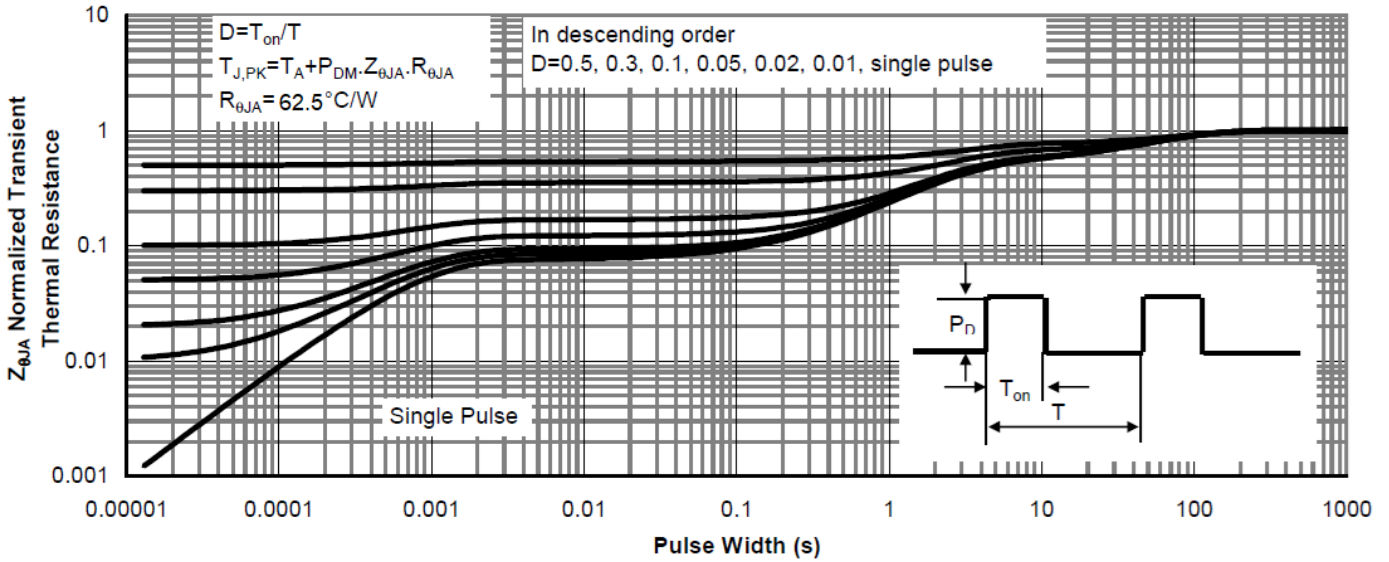
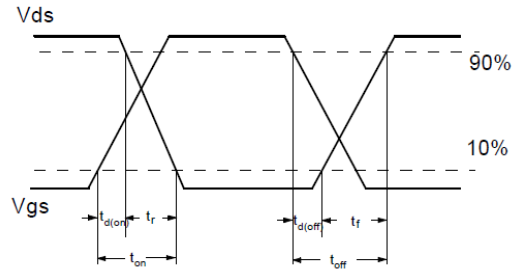
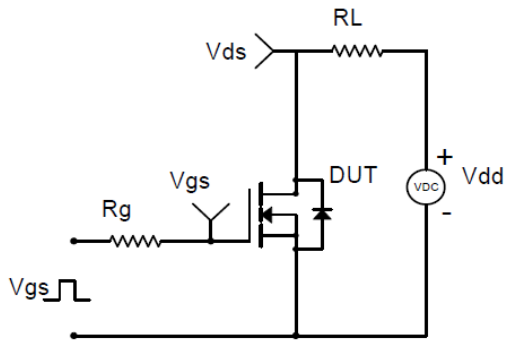
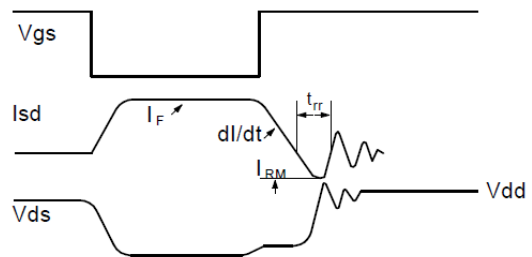
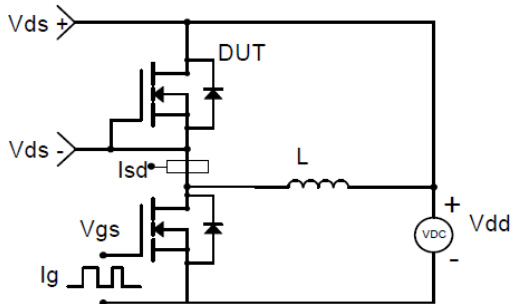


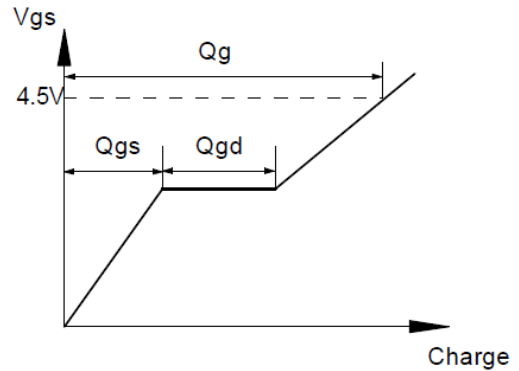
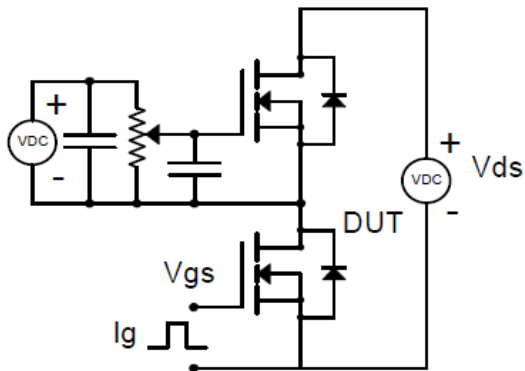
Figure9. Normalized Maximum Transient Thermal Impedance



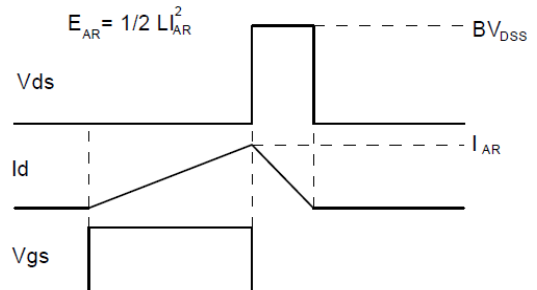
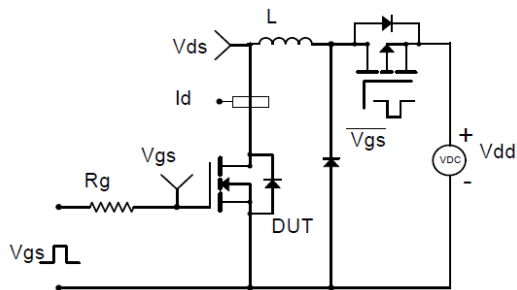
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Gate Charge Test Circuit & Waveform

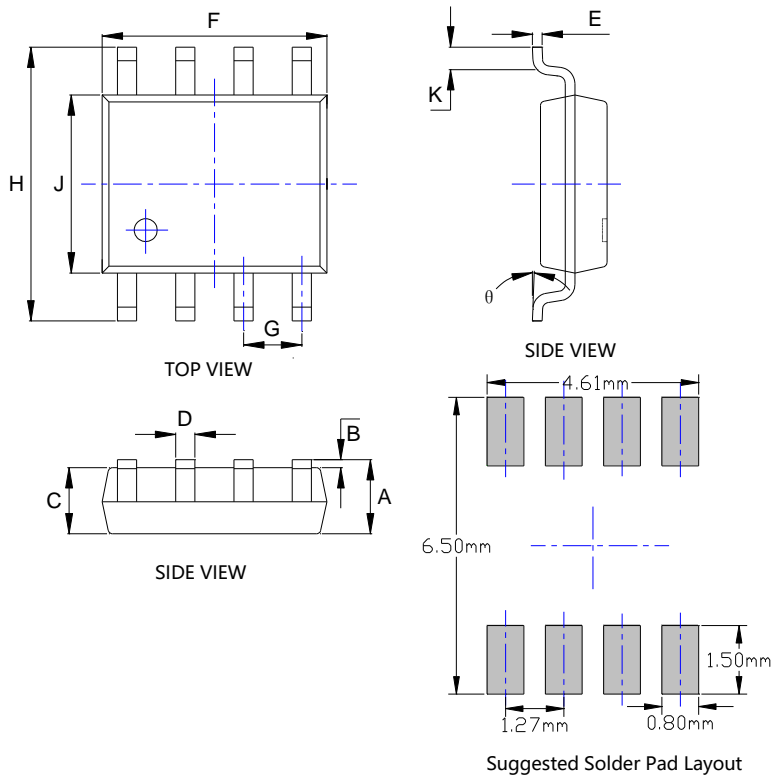


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



YJS4606A

■ SOP-8 Package information



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.053	0.069	1.350	1.750
B	0.004	0.010	0.100	0.250
C	0.053	0.061	1.350	1.550
D	0.013	0.020	0.330	0.510
E	0.007	0.010	0.170	0.250
F	0.189	0.197	4.800	5.000
G	0.050BSC		1.270BSC	
H	0.228	0.244	5.800	6.200
J	0.150	0.157	3.800	4.000
K	0.016	0.050	0.400	1.270
θ	0°	8°	0°	8°

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



YJS4606A

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